

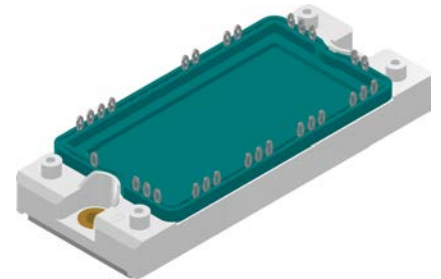
Standard Rectifier Module

3~ Rectifier	Brake Chopper
$V_{RRM} = 2200\text{ V}$	$V_{CES} = 1200\text{ V}$
$I_{DAV} = 210\text{ A}$	$I_{C25} = 120\text{ A}$
$I_{FSM} = 1000\text{ A}$	$V_{CE(sat)} = 1,9\text{ V}$

3~ Rectifier Bridge + Brake Unit + NTC

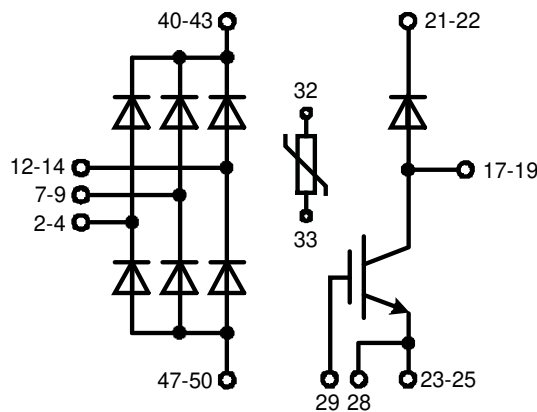
Part number

MDMA210UB1600PTED



Backside: isolated

 E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- NTC

Applications:

- 3~ Rectifier with brake unit for drive inverters

Package: E2-Pack

- Isolation Voltage: 4300 V~
- Industry standard outline
- RoHS compliant
- PressFit-Pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

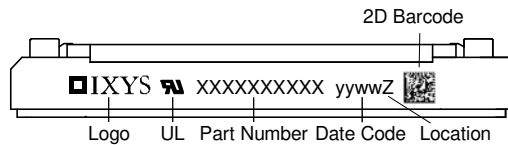
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Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}\text{C}$		2300	V
V_{RRM}	max. repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}\text{C}$		2200	V
I_R	reverse current	$V_R = 2200\text{ V}$		$T_{VJ} = 25^{\circ}\text{C}$		100	μA
		$V_R = 2200\text{ V}$		$T_{VJ} = 150^{\circ}\text{C}$		2	mA
V_F	forward voltage drop	$I_F = 70\text{ A}$		$T_{VJ} = 25^{\circ}\text{C}$		1,23	V
		$I_F = 210\text{ A}$				1,75	V
		$I_F = 70\text{ A}$		$T_{VJ} = 125^{\circ}\text{C}$		1,19	V
		$I_F = 210\text{ A}$				1,67	V
I_{DAV}	bridge output current	$T_C = 85^{\circ}\text{C}$		$T_{VJ} = 150^{\circ}\text{C}$		210	A
		rectangular	$d = \frac{1}{3}$				
V_{FO}	threshold voltage	} for power loss calculation only		$T_{VJ} = 150^{\circ}\text{C}$		0,82	V
r_F	slope resistance					5,2	m Ω
R_{thJC}	thermal resistance junction to case					0,5	K/W
R_{thCH}	thermal resistance case to heatsink				0,1		K/W
P_{tot}	total power dissipation			$T_C = 25^{\circ}\text{C}$		250	W
I_{FSM}	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}\text{C}$		1,00	kA
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		1,08	kA
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}\text{C}$		850	A
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		920	A
I^2t	value for fusing	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}\text{C}$		5,00	kA ² s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		4,85	kA ² s
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}\text{C}$		3,62	kA ² s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		3,52	kA ² s
C_J	junction capacitance	$V_R = 400\text{ V}; f = 1\text{ MHz}$		$T_{VJ} = 25^{\circ}\text{C}$		33	pF

Brake IGBT + Diode				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
V_{CES}	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V	
V_{GES}	max. DC gate voltage				± 20	V	
V_{GEM}	max. transient gate emitter voltage				± 30	V	
I_{C25}	collector current	$T_C = 25^{\circ}\text{C}$			120	A	
I_{C80}		$T_C = 80^{\circ}\text{C}$			84	A	
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$			390	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 77\text{ A}; V_{GE} = 15\text{ V}$			1,9	V	
					2,2	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 3\text{ mA}; V_{GE} = V_{CE}$	5,4	5,9	6,5	V	
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$			0,2	mA	
					0,6	mA	
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 77\text{ A}$		230		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 77\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 10\ \Omega$		70		ns	
t_r	current rise time			40		ns	
$t_{d(off)}$	turn-off delay time			250		ns	
t_f	current fall time			100		ns	
E_{on}	turn-on energy per pulse			6,8		mJ	
E_{off}	turn-off energy per pulse			8,3		mJ	
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 10\ \Omega$					
I_{CM}		$V_{CEK} = 1200\text{ V}$			225	A	
SCSOA	short circuit safe operating area	$V_{CEK} = 1200\text{ V}$					
t_{SC}	short circuit duration	$V_{CE} = 900\text{ V}; V_{GE} = \pm 15$			10	μs	
I_{SC}	short circuit current	$R_G = 10\ \Omega; \text{non-repetitive}$		300		A	
R_{thJC}	thermal resistance junction to case				0,32	K/W	
R_{thCH}	thermal resistance case to heatsink				0,10	K/W	
Brake Diode							
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V	
I_{F25}	forward current	$T_C = 25^{\circ}\text{C}$			88	A	
I_{F80}		$T_C = 80^{\circ}\text{C}$			59	A	
V_F	forward voltage	$I_F = 60\text{ A}$			2,20	V	
					1,95	V	
I_R	reverse current	$V_R = V_{RRM}$			0,1	mA	
					1,2	mA	
Q_{rr}	reverse recovery charge	$V_R = 600\text{ V}$ $-di_F/dt = 1200\text{ A}/\mu\text{s}$ $I_F = 60\text{ A}; V_{GE} = 0\text{ V}$		8		μC	
I_{RM}	max. reverse recovery current			60		A	
t_{rr}	reverse recovery time			350		ns	
E_{rec}	reverse recovery energy			2,5		mJ	
R_{thJC}	thermal resistance junction to case				0,6	K/W	
R_{thCH}	thermal resistance case to heatsink				0,1	K/W	

Package E2-Pack		Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			30	A
T_{VJ}	virtual junction temperature		-40		150	°C
T_{op}	operation temperature		-40		125	°C
T_{stg}	storage temperature		-40		125	°C
Weight				176		g
M_D	mounting torque		3		6	Nm
$d_{Spp/APP}$	creepage distance on surface / striking distance through air	terminal to terminal	6,0			mm
$d_{Spb/APb}$		terminal to backside	12,0			mm
V_{ISOL}	isolation voltage	t = 1 second t = 1 minute	4300			V
		50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3600			V


Part description

M = Module
 D = Diode
 M = Standard Rectifier
 A = (up to 1800V)
 210 = Current Rating [A]
 UB = 3- Rectifier Bridge + Brake Unit
 1600 = Reverse Voltage [V]
 PT = PressFit-Pin, Thermistor
 ED = E2-Pack
 - = Hyphen
 PC = Phase Change Material

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MDMA210UB1600PTED	MDMA210UB1600PTED	Blister	28	516606
Alternative	MDMA210UB1600PTED-PC	MDMA210UB1600PTED	Blister	28	515409

Temperature Sensor NTC

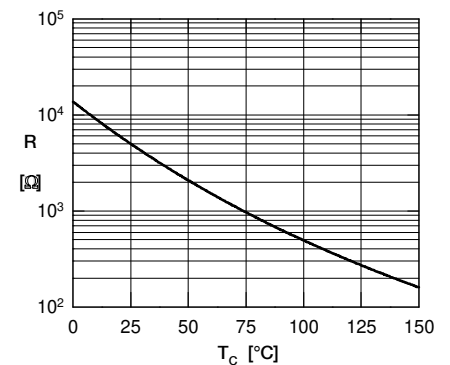
Symbol	Definition	Conditions	min.	typ.	max.	Unit
R_{25}	resistance	$T_{VJ} = 25^\circ$	4,85	5	5,15	k Ω
$B_{25/50}$	temperature coefficient			3375		K

Equivalent Circuits for Simulation

* on die level

 $T_{VJ} = 150^\circ\text{C}$

	Rectifier	Brake IGBT +	Brake Diode	
V_0	0,82	1,1	1,22	V
R_0	3,1	17,9	13	m Ω



Typ. NTC resistance vs. temperature

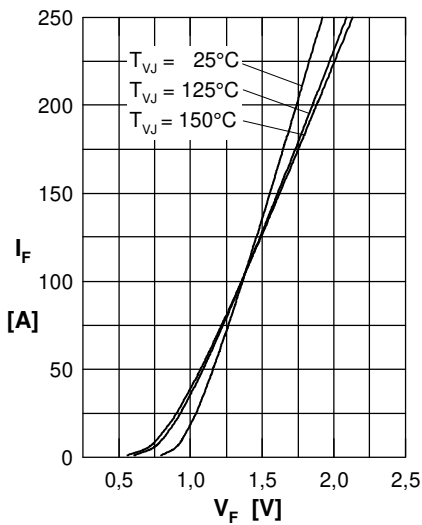
Rectifier


Fig. 1 Forward current versus voltage drop per diode

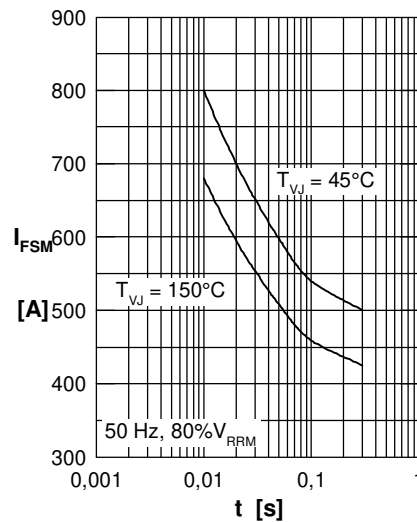


Fig. 2 Surge overload current vs. time per diode

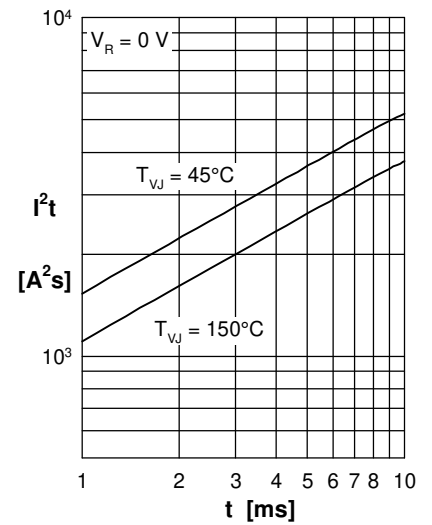
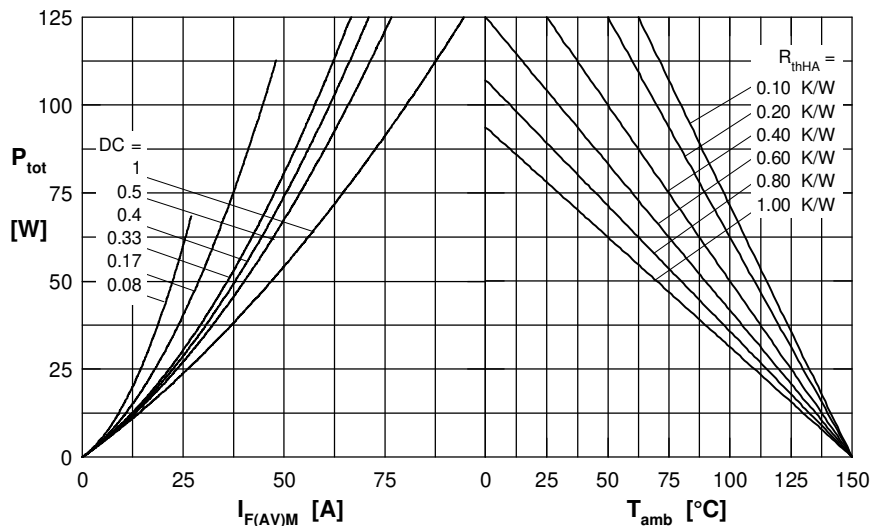

 Fig. 3 I^2t versus time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

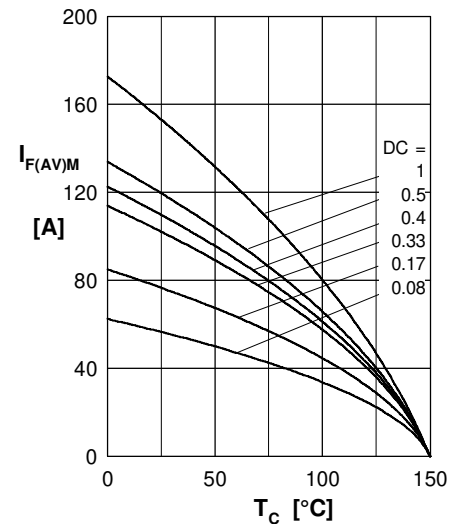


Fig. 5 Max. forward current vs. case temperature per diode

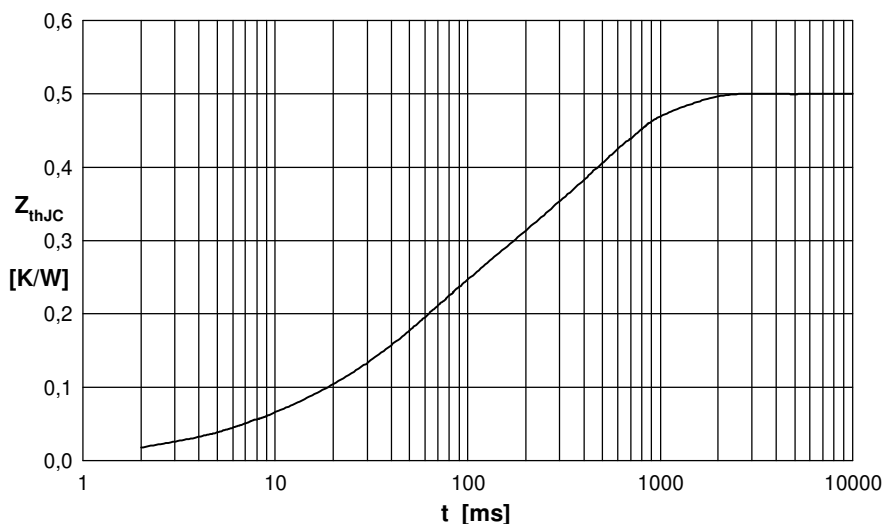


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.030	0.006
2	0.003	0.007
3	0.182	0.045
4	0.285	0.450